

Renesas RA Family

EK-RA2A1 Example Project Bundle

Introduction

This document describes the contents of the Example Project Bundle for the EK-RA2A1 kit. The Example Projects contained within the bundle show how to write code for the various Renesas Flexible Software Package (FSP) modules supported by the EK-RA2A1 kit.

Flexible Software Package is an optimized software package designed to provide easy to use, scalable, high-quality software for embedded system design. The primary goal is to provide lightweight, efficient drivers that meet common use cases in embedded systems. FSP code quality is enforced by peer reviews, automated requirements-based testing, and automated static analysis. FSP provides uniform and intuitive APIs that are well documented. Each module is supported with detailed user documentation including example code. FSP modules can be used on any MCU in the RA family, provided the MCU has any peripherals required by the module. FSP modules can be configured at build-time to optimize the size of the module for the feature set required by the application.

Supported Kit

EK-RA2A1

Supported FSP Version

FSP v5.2.0

Supported Toolchains

For the latest version of each Integrated Development Environment (IDE) and toolchain listed below, please refer to the FSP release notes

- e² studio with GCC Arm Embedded
- · Keil MDK with Arm compiler toolchain
- IAR EWARM with IAR toolchain for Arm

1. Using the Example Projects

To use EK-RA2A1 Example Projects, follow the steps mentioned in the following documents:

- Example Project Usage Guide
 https://github.com/renesas/ra-fsp-examples/blob/master/example_projects/Example%20Project%20Usage%20Guide.pdf
- e² studio AC6 porting Guide https://en-support.renesas.com/knowledgeBase/19375553

Users who are new to the FSP are recommended to refer to the section **Starting Development > Tutorial: Your First RA MCU Project – Blinky** in the <u>RA FSP Documentation</u> prior to attempting to program or debug an example project.

2. List of Example Projects Supported on Different Toolchains in the Bundle

The following table lists example projects supported by each IDE. These are ready to import using the import process for each IDE.

Note:

- 1. Additional example projects other than those mentioned above, may be available in the example_project repository. However, they are supported with older version of FSP. Please refer the example_projects/version_info_table.md file in the repository to identify the appropriate FSP version for the example project of interest.
- 2. All projects supported by e² studio/GCC are supported with e² studio/AC6 via port from GCC.

Table 1. IDE Support for the Example Project

	IDE Support		
Example Project	e ² studio/GCC	IAR	Keil MDK
_quickstart	Supported		
acmplp	Supported		
adc	Supported		
adc_gpt_periodic_sampling	Supported		
agt	Supported	Supported	Supported
audio_playback_pwm	Supported		
cac	Supported		
can	Supported	Supported	
can_fifo	Supported		
срр	Supported		
crc	Supported		
dac	Supported		
dac8	Supported		
dac_agt_periodic_signal_generator	Supported		
doc	Supported		
elc	Supported		
flash_lp	Supported	Supported	Supported
freertos	Supported	Supported	Supported
gpt	Supported	Supported	Supported
gpt_input_capture	Supported		
icu	Supported	Supported	Supported
iic_master	Supported		
iic_slave	Supported	Supported	Supported
iwdt	Supported		
kint	Supported		
lpm	Supported		
lvd	Supported		
opamp	Supported		
rtc	Supported	Supported	Supported
sci_i2c	Supported		
sci_spi	Supported		
sci_uart	Supported	Supported	Supported
sdadc	Supported		
spi	Supported	Supported	Supported
usb_pcdc	Supported		
usb_pcdc_with_freertos	Supported		
usb_phid	Supported		

	IDE Support		
Example Project	e ² studio/GCC	IAR	Keil MDK
usb_pvnd	Supported		
vee_flash	Supported		
wdt	Supported	Supported	Supported

Website and Support

Visit the following URLs to learn about key elements of the RA family, download components and related documentation, and get support.

RA Product Information renesas.com/ra
RA Product Support Forum renesas.com/ra/forum
RA Flexible Software Package renesas.com/FSP
Renesas Support renesas.com/support



Revision History

Rev.DatePageSummary1.00Apr.23.20—First release document.1.01May.29.20—Examples updated for IAR support.1.02Jul.09.20—Updated for FSP v1.2.0.1.03Jul.23.20—Updated for new EPs supported in FSP v1.2.0.1.04Aug.12.20NAPackage updated to include this document.1.05Sep.03.20—Support for FSP v1.3.0 EPs.	Description		
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1.30 Nov.14.22 — Added support for FSP v4.1.0.			
1.31 Dec.01.22 — Added support for FSP v4.1.0 (2).			
1.32 Jan.10.23 — Added support for FSP v4.2.0 (1).			
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1.34 Apr.28.23 — Added support for FSP v4.4.0 (1).			
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1.36 Jul.17.23 — Added support for FSP v4.5.0 (1).			
1.37 Sep.18.23 — Added support for FSP v4.5.0 (2).			
1.38 Sep.26.23 — Added support for FSP v4.6.0 (1).			
1.39 Oct.23.23 — Added support for FSP v4.6.0 (2).			
1.40 Nov.06.23 — Added support for FSP v5.0.0 (2).			
1.41 Dec.05.23 — Added support for FSP v5.0.0 (3).			
1.42 Dec.19.23 — Added support for FSP v5.1.0 (2).			
1.43 Jan.29.24 — Added support for FSP v5.1.0 (4).			
1.44 Mar.11.24 — Added support for FSP v5.2.0 (1).			



1.45	Mar.21.24	_	Added support for FSP v5.2.0 (2).
1.46	Apr.09.24		Added support for FSP v5.2.0 (3).

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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